

Product Change Notification / ALAN-12ZCOT961

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03-May-2024

Product Category:

Memory

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6580 Final Notice: Qualification of NSEB and UTL3 as additional assembly sites for selected SST25PF040C-40xx and SST25PF040CT-40xx device families available in 8L TDFN-S (6x5x0.8mm) package.

Affected CPNs:

ALAN-12ZCOT961_Affected_CPN_05032024.pdf ALAN-12ZCOT961_Affected_CPN_05032024.csv

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of NSEB and UTL3 as additional assembly sites for selected SST25PF040C-40xx and SST25PF040CT-40xx device families available in 8L TDFN-S (6x5x0.8mm) package.

Pre and Post Change Summary:

Pre Change	Post Change
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Assembly Site	Lingsen Precision Industries, LTD. (LPI)	Lingsen Precision Industries, LTD. (LPI)	UTAC Thai Limited (UTL-1) LTD. (NSEB)			
Wire Material	Au	Au	Au	Au		
Die Attach Material	8340	8340	558-2C31	558-2C31		
Molding Compound Material	G770HT	G770HT	G700LTD	G700LTD		
Lead-Frame Material	C194	C194	C194	C194		
Lead-Frame Paddle Size	142X165 mils	142X165 mils	150X173 mils	150X173 mils		
Lead-Lock	No	No	Yes	Yes		
DAP Surface Prep	Ag Spot Plating	Ag Spot Plating	Ag on lead only	Ag on lead only		

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve on-time delivery performance by qualifying UTL-1 and UTL3 as an additional assembly site.

Change Implementation Status:In Progress

Estimated First Ship Date:May 31, 2024 (date code: 2422)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	October 2023			>	May 2024						
Workweek	4 0	4 1	4 2	4 3	4 4		1 8	1 9	2	2 1	2 2
Initial PCN Issue Date			Х								
Qual Report Availability							Х				
Final PCN Issue Date							Х				
Estimated Implementation Date											Х

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:October 18, 2023: Issued initial notification.

May 3, 2024: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on May 31, 2024.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_ALAN-12ZCOT961_Qual Report.pdf PCN_ALAN-12ZCOT961_Pre and Post Change_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

SST25PF040C-40E/MF18GVAO

SST25PF040C-40I/MF

SST25PF040C-40I/MF18GVAO

SST25PF040C-40V/MF18GVAO

SST25PF040CT-40V/MF18GVAO

SST25PF040CT-40I/MF

SST25PF040CT-40I/MF18GVAO

SST25PF040CT-40E/MF18GVAO

SST25PF040C-40E/MF

SST25PF040C-40V/MF

SST25PF040CT-40V/MF

SST25PF040CT-40E/MF

Date: Friday, May 3, 2024